

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ming-Fan Tsai	08/11/2011
Hsin-Hung Lee	08/11/2011
Bo-Shiang Fang	08/11/2011
RECEIVING PARTY DATA	
Name:	Siliconware Precision Industries Co., Ltd.
Street Address:	No. 123, Sec. 3, Da Fong Road, Tantz
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State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13242941
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NAME OF SUBMITTER:	Peter F. Corless
Total Attachments: 1 source=89338_Assignment#page1.tif	

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ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) 1. Ming-Fan TSAI 2. Hsin-Hung LEE
Full Name(s) 3. Bo-Shiang FANG

Hereby sell, assign and transfer to

Assignee SILICONWARE PRECISION INDUSTRIES CO., LTD.
Name and Address No. 123, Sec. 3, Da Fong Road, Tantz,
Taichung, Taiwan, R.O.C.

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

Title of Invention: LAYER STRUCTURE WITH EMI SHIELDING EFFECT

Which application was

Complete either a) executed by the undersigned on _____
b) filed on the _____
Serial No. _____

Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date Signed at TAIWAN, R.O.C.
On August 11, 2011

Inventor(s) Ming-Fan TSAI
Full Signature(s) Hsin-Hung Lee Hsin-Hung LEE
Bo-Shiang Fang Bo-Shiang FANG